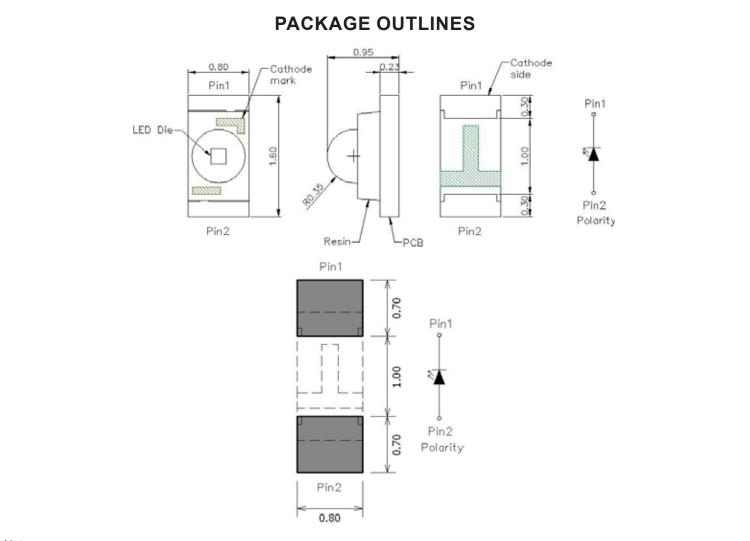


SPECIFICATION CSDK63B2C



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
CSDK63B2C	InGaN	Blue	Water Clear	36°	



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ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	20	mA	
Reverse Current @ 5V	lR	10	μΑ	
Power Dissipation	Pd	78	mW	
Operating Temperature Range	Тор	-40~+85	°C	
Storage Temperature Range	Тѕтс	-40~+100	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lFP	60	mA	
Soldering Temperature	TsoL	Max 260°C for 10 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Darameter	Symbol	Toot Condition	Value			Lloit
Parameter		Test Condition	Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 20mA	1	520	-	mcd
Forward Voltage	VF	IF = 20mA	1	3.2	3.9	V
Reverse Leakage Current	lR	VR = 5V	-	10	-	μΑ
Viewing Angle at 50% Iv	201/2	IF = 20mA	ı	36	-	Deg
Peak Wavelength	λР	IF = 20mA	1	468	ı	nm
Dominant Wavelength	λD	IF = 20mA	-	470	-	nm

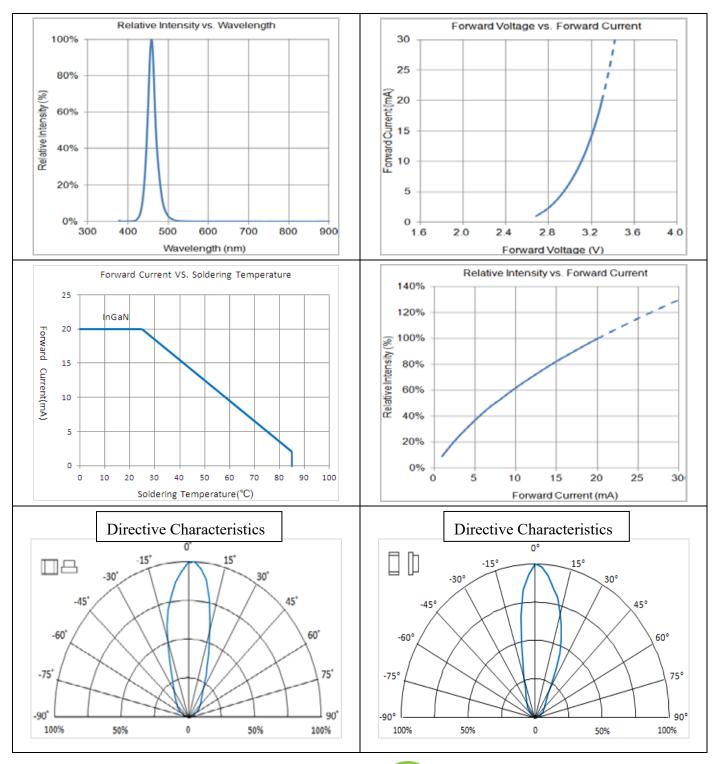
^{*}Tolerance of viewing angle: -10 / +5 deg.

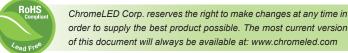


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OPTICAL CHARACTERISTIC CURVES

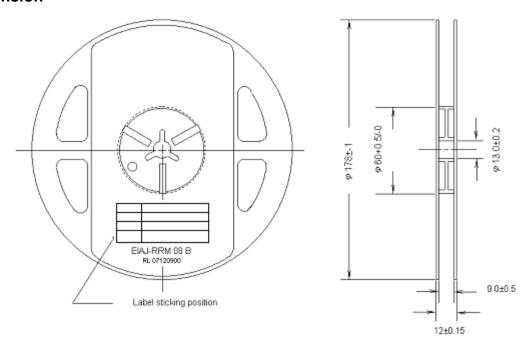


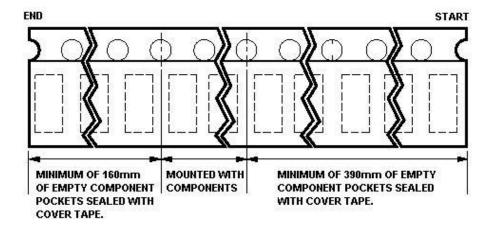




PACKAGING SPECIFICATION

Reel Dimension







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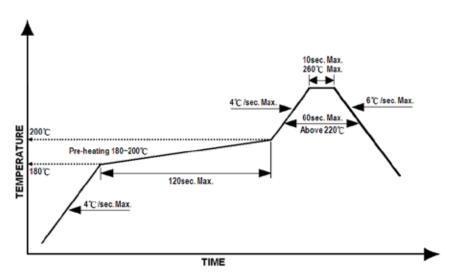
SOLDERING CONDITIONS

Reflow Soldering

Recommend soldering paste specifications:

- 1. Operating temp.: Above 220°C ,60sec
- 2. Peak temp.:260°C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- Never take next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measuring on the surface of the LED terminal) is following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min

